Programmable timer Rev. 2 — 31 December 2013

Product data sheet

1. General description

The HEF4541B-Q100 is a programmable timer. It consists of a 16-stage binary counter, an integrated oscillator to be used with external timing components, an automatic power-on reset and output control logic. The external components R_{TC} and C_{TC} determines the frequency of the oscillator within the frequency range 1 Hz to 100 kHz. An external clock signal at input RS can replace the oscillator. The timer advances on the positive-going transition of RS. A LOW on the auto reset input (AR) and a LOW on the master reset input (MR) enables the internal power-on reset. A HIGH level at input MR resets the counter independent on all other inputs. Resetting, disables the oscillator to provide no active power dissipation.

A HIGH at input AR turns off the power-on reset to provide a low quiescent power dissipation of the timer. The 16-stage counter divides the oscillator frequency by 2^8 , 2^{10} , 2^{13} or 2^{16} depending on the state of the address inputs (A0, A1). The divided oscillator frequency is available at output O. The phase input (PH) features a complementary output signal. When the mode select input (MODE) is LOW the timer is a single transition timer and when HIGH the timer is a 2^n frequency divider.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Complies with JEDEC standard JESD 13-B



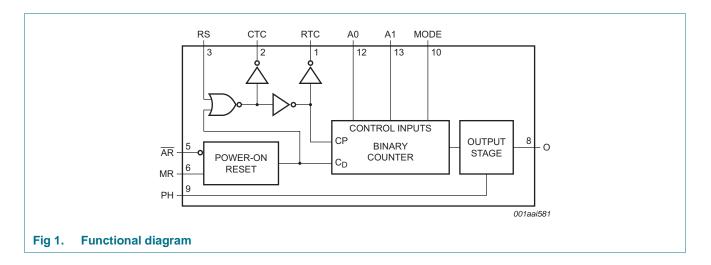
3. Ordering information

Table 1. Ordering information

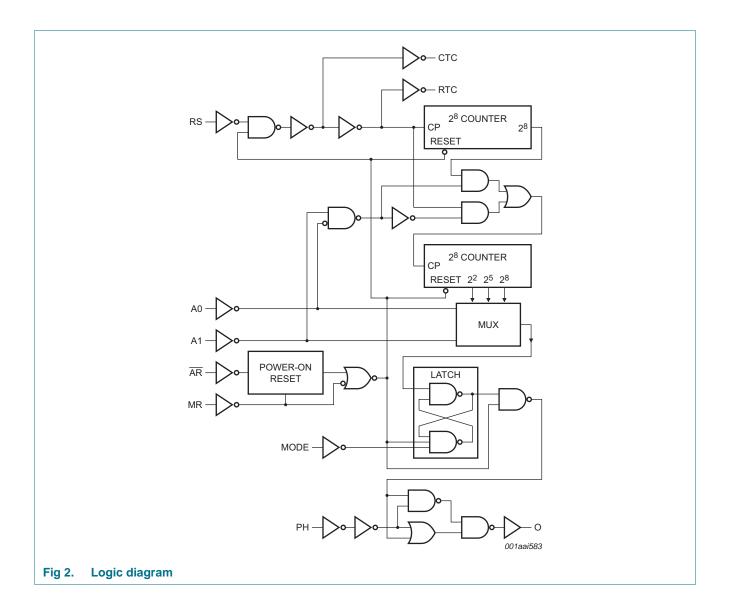
All types operate from -40 °C to +125 °C.

Type number	Package	Package					
	Name	Description	Version				
HEF4541BT-Q100	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1				

4. Functional diagram

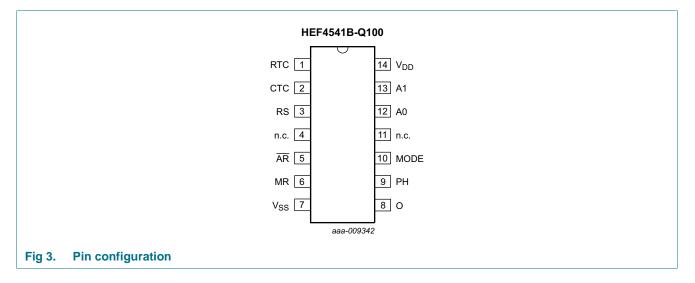


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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
RTC	1	external resistor connection
CTC	2	external capacitor connection
RS	3	external resistor connection (RS) or external clock input
nc	4, 11	not connected
AR	5	auto reset input (active low)
MR	6	master reset input
V_{SS}	7	ground (0 V)
0	8	timer output
PH	9	phase input
MODE	10	mode select input
A0, A1	12, 13	address inputs
V_{DD}	14	supply voltage

6. Functional description

Table 3.Function table

Input			MODE	
AR	MR	PH	MODE	
Н	L	x	Х	auto reset disabled
L	L	Х	Х	auto reset enabled ^[2]
Х	Н	Х	Х	master reset active
Х	L	Х	Н	normal operation selected division to output
Х	L	Х	L	single-cycle mode ^[3]
Х	L	L	Х	output initially LOW after reset
Х	L	Н	Х	output initially HIGH, after reset

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

[2] For correct power-on reset, the supply voltage should be above 8.5 V. For V_{DD} < 8.5 V, disable the auto reset and connect \overline{AR} to V_{DD} .

[3] The timer is initialized on a reset pulse and the output changes state after 2ⁿ⁻¹ counts and remains in that state (latched). A master reset or a LOW to HIGH transition on the MODE input, resets this latch.

Table 4. Frequency selection table

A0	A1	Number of counter stages n	$\frac{f_{osc}}{f_o} = 2^n$
L	L	13	8192
L	Н	10	1024
Н	L	8	256
Н	Н	16	65536

7. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I _{I/O}	input/output current	O output	-	±10	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+125	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[1]</u> _	500	mW
Р	power dissipation		-	100	mW

[1] For SO14 package: Ptot derates linearly with 8 mW/K above 70 °C.

8. Recommended operating conditions

Recommended operating condition	S			
Parameter	Conditions	Min	Max	Unit
supply voltage		3	15	V
input voltage		0	V_{DD}	V
ambient temperature	in free air	-40	+125	°C
input transition rise and fall rate	$V_{DD} = 5 V$	-	3.75	μs/V
	V _{DD} = 10 V	-	0.5	μs/V
	V _{DD} = 15 V	-	0.08	μs/V
	Parameter supply voltage input voltage ambient temperature	ParameterConditionssupply voltageinput voltageinput voltagein free airambient temperaturein free airinput transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinsupply voltage3input voltage0ambient temperaturein free air-40input transition rise and fall rate $V_{DD} = 5 V$ - $V_{DD} = 10 V$	ParameterConditionsMinMaxsupply voltage315input voltage0 V_{DD} ambient temperaturein free air-40+125input transition rise and fall rate $V_{DD} = 5 V$ -3.75 $V_{DD} = 10 V$ -0.5

9. Static characteristics

Table 7. Static characteristics

 $V_{SS} = 0$ V; $V_{I} = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	85 °C	T _{amb} =	125 °C	Unit
				Min	Max	Min	Мах	Min	Max	Min	Max	
V _{IH}	HIGH-level	$ I_0 < 1 \ \mu A$	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level	$ I_0 < 1 \ \mu A$	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage	ut voltage	10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V _{OL}	LOW-level	I _O < 1 μΑ	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level	CTC, RTC;										
	output current	$V_{O} = 2.5 V$	5 V	-	-1.4	-	-1.2	-	-0.95	-	-0.95	mA
		$V_{O} = 4.6 V$	5 V	-	-0.5	-	-0.4	-	-0.3	-	-0.3	mA
		$V_{O} = 9.5 V$	10 V	-	-1.4	-	-1.2	-	-0.95	-	-0.95	mA
		V _O = 13.5 V	15 V	-	-4.8	-	-4.0	-	-3.2	-	-3.2	mA
		O;										
		$V_{O} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
		$V_{O} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA

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Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	= 25 °C	T _{amb} =	= 85 °C	T _{amb} =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I _{OL}	I _{OL} LOW-level output current	CTC, RTC;										
		$V_{O} = 0.4 V$	5 V	0.33	-	0.27	-	0.20	-	0.20	-	mA
		$V_{O} = 0.5 V$	10 V	1.0	-	0.85	-	0.68	-	0.68	-	mA
		$V_{O} = 1.5 V$	15 V	3.2	-	2.7	-	2.3	-	2.3	-	mA
		О;										
		$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.2	-	2.4	-	2.4	-	mA
I _I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA
I _{DD}	supply current	$I_{O} = 0 A$	5 V	-	5	-	5	-	150	-	150	μA
			10 V	-	10	-	10	-	300	-	300	μA
			15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

Table 7. Static characteristics ...continued

 $V_{SS} = 0$ V; $V_{I} = V_{SS}$ or V_{DD} ; unless otherwise specified.

Table 8.Reset characteristics

 $V_{SS} = 0 V$; $V_I = V_{SS}$ or V_{DD} ; see <u>Table 12</u> for test conditions; unless otherwise specified.

Symbol	Parameter Conditions		V _{DD}	T _{amb} =	–40 °C	Tamb	, = +2	5 ℃	T _{amb} =	+85 °C	T _{amb} = +	-125 °C	Unit
				Min	Max	Min	Тур	Max	Min	Max	Min	Max	
I _{DD}	supply current		5 V	-	80	-	20	80	-	230	-	230	μΑ
	for power-on		10 V	-	750	-	250	600	-	700	-	700	μΑ
	$\frac{\text{reset enable;}}{\text{AR} = \text{MR} = 0 \text{ V;}}$ Other inputs at 0 V or V _{DD}	15 V	-	1.6	-	0.5	1.3	-	1.5	-	1.5	mA	
V _{DD}	supply voltage	supply voltage for automatic reset initialization; $\overline{AR} = MR = 0 V$; Other inputs at 0 V or V _{DD}	-	-	-	8.5	5	-	-	-	-	-	V

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10. Dynamic characteristics

Table 9. Dynamic characteristics

 $V_{SS} = 0$ V; $T_{amb} = 25$ °C unless otherwise specified. For test circuit, see Figure 5.

Symbol	Parameter	Conditions	V_{DD}		Extrapolation formula	Min	Typ <mark>[1]</mark>	Мах	Unit			
t _{pd}	propagation delay	RS to O;	5 V	[2]	348 ns + (0.55 ns/pF)C _L	-	375	750	ns			
		2 ⁸ selected; see Figure 4	10 V		139 ns + (0.23 ns/pF)C _L	-	150	300	ns			
		See <u>rigure 4</u>	15 V		102 ns + (0.16 ns/pF)C _L	-	110	220	ns			
		RS to O;	5 V		398 ns + (0.55 ns/pF)C _L	-	425	850	ns			
		2 ¹⁰ selected; see Figure 4	10 V		154 ns + (0.23 ns/pF)C _L	-	165	330	ns			
		See <u>rigue 4</u>	15 V		112 ns + (0.16 ns/pF)C _L	-	120	240	ns			
		RS to O; 2 ¹³ selected; see Figure 4	5 V		483 ns + (0.55 ns/pF)C _L	-	510	1020	ns			
			10 V		179 ns + (0.23 ns/pF)C _L	-	190	380	ns			
		See <u>Figure 4</u>	15 V		127 ns + (0.16 ns/pF)C _L	-	135	270	ns			
		RS to O; 2 ¹⁶ selected; see <u>Figure 4</u>	5 V		548 ns + (0.55 ns/pF)C _L	-	575	1150	ns			
			10 V		199 ns + (0.23 ns/pF)C _L	-	210	420	ns			
			15 V		142 ns + (0.16 ns/pF)C _L	-	150	300	ns			
t _W	pulse width	RS LOW; MR HIGH;	5 V	[3]		60	30	-	ns			
						MR HIGH; see Figure 4	10 V			30	15	-
		366 <u>1 igure 4</u>	15 V			24	12	-	ns			
f _{clk(max)}	maximum clock	RS; see Figure 4	5 V			8	16	-	MHz			
	frequency		10 V			15	30	-	MHz			
			15 V			18	36	-	MHz			
f _{osc}	oscillator frequency	$R_t = 5 k\Omega;$	5 V			-	90	-	kHz			
		$C_t = 1 \text{ nF};$ $R_S = 10 \text{ k}\Omega;$	10 V			-	90	-	kHz			
		see Figure 6	15 V			-	90	-	kHz			
		R _t = 56 kΩ;	5 V			-	8	-	kHz			
		$C_t = 1 \text{ nF};$	10 V			-	8	-	kHz			
		R _S = 120 kΩ; see <mark>Figure 6</mark>	15 V			-	8	-	kHz			

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

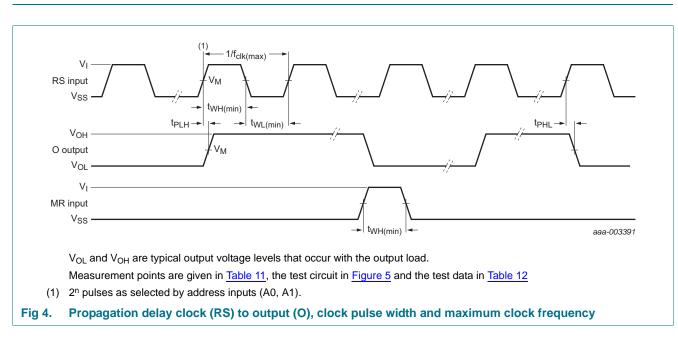
[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

 $\label{eq:WL(min)} [3] \quad t_W \text{ is the same as } t_{WL(min)} \text{ and } t_{WH(min)}.$

P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.								
Symbol	Parameter	V_{DD}	Typical formula					
P _D	dynamic power dissipation	Per pa	ckage					
			$P_{D} = 1300 \times f_{i} + (f_{o} \times C_{L} \times V_{DD}^{2}) \ \mu W$					
		10 V	$P_{D} = 5300 \times f_{i} + (f_{o} \times C_{L} \times V_{DD}^{2}) \ \mu W$					
		15 V	$P_{D} = 12000 \times f_{i} + (f_{o} \times C_{L} \times V_{DD}^{2}) \ \mu W$					
		Total, ι	using the on-chip oscillator					
		5 V	$P_D = 1300 \times f_{osc} + f_o C_L V_DD^2 + 2C_TC V_DD^2 f_{osc} + 10 V_DD \mu W$					
		10 V	$P_{D} = 5300 \times f_{osc} + f_{o}C_{L}V_{DD}^{2} + 2C_{TC}V_{DD}^{2} f_{osc} + 100V_{DD} \mu W$					
		15 V	$P_{D} = 12000 \times f_{osc} + f_{o}C_{L}V_{DD}^{2} + 2C_{TC}V_{DD}^{2} f_{osc} + 400V_{DD} \mu W$					

Table 10.Dynamic power dissipation

[1] f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{DD} = supply voltage in V; f_{osc} = oscillator frequency in MHz; C_{TC} = timing capacitance in pF.



11. Waveforms

Table 11. Measurement points

Supply voltage	Input	Output
V _{DD}	V _M	V _M
5 V to 15 V	0.5V _{DD}	0.5V _{DD}

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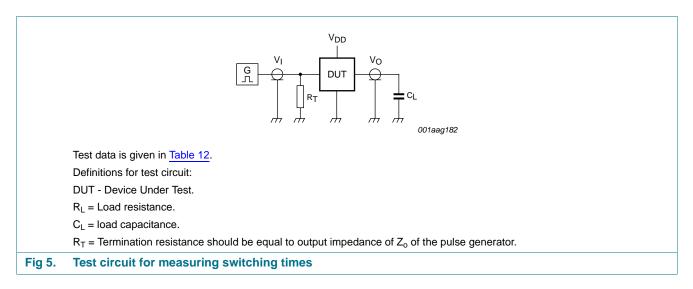


Table 12. Test data

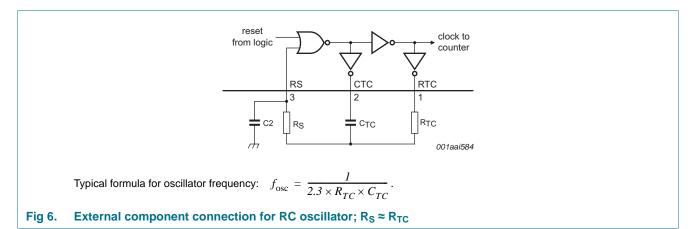
Supply	Input		Load
V _{DD}	VI	t _r , t _f	CL
5 V to 15 V	V _{SS} or V _{DD}	\leq 20 ns	50 pF

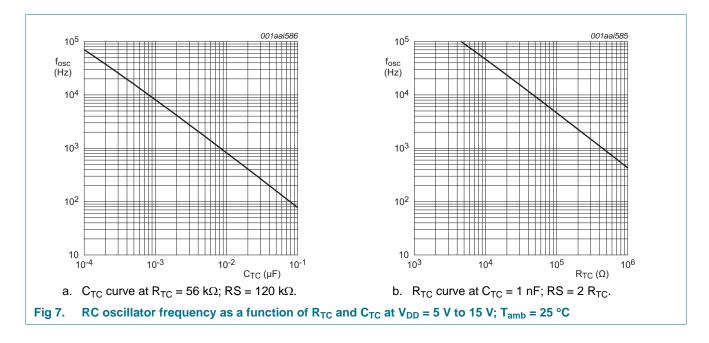
12. Application information

RC oscillator timing component limitations

 $R_{TC}C_{TC}$ determines the oscillator frequency, provided $R_{TC} << R_S$ and $R_SC_2 << R_{TC}C_{TC}$. The function of R_S is to minimize the influence of the forward voltage across the input protection diodes on the frequency. The stray capacitance C_2 should be kept as small as possible. In consideration of accuracy, C_{TC} must be larger than the inherent stray capacitance. R_{TC} must be larger than the LOCMOS 'ON' resistance in series with it, which typically is 500 Ω at V_{DD} = 5 V, 300 Ω at V_{DD} = 10 V and 200 Ω at V_{DD} = 15 V.

The recommended values for these components to maintain agreement with the typical oscillation formula are: $C_{TC} \ge 100 \text{ pF}$, up to any typical value, $10 \text{ k}\Omega \le R_{TC} \le 1 \text{ M}\Omega$.

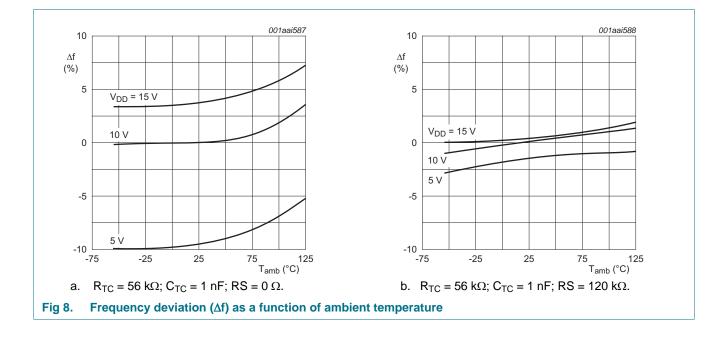




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13. Package outline

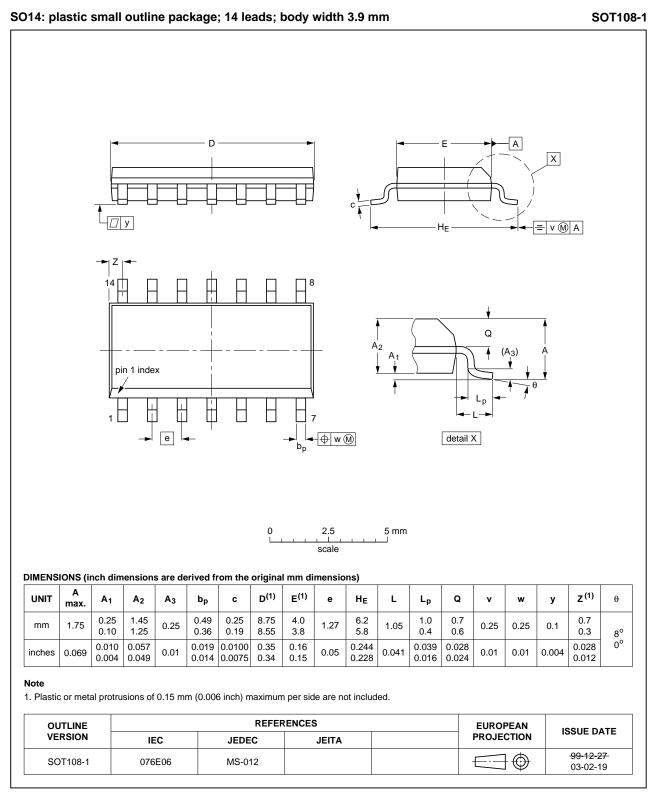


Fig 9. Package outline SOT108-1 (SO14)

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HEF4541B_Q100



14. Abbreviations

Table 13.	Abbreviations	
Acronym		Description
CMOS		Complementary Metal Oxide Semiconductor
DUT		Device Under Test
ESD		ElectroStatic Discharge
HBM		Human Body Model
MIL		Military
MM		Machine Model
TTL		Transistor-Transistor Logic

15. Revision history

Table 14. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4541B_Q100 v.2	20131231	Product data sheet	-	HEF4541B_Q100 v.1
Modifications:	 Maximum te 	emperature changed to 125	°C throughout.	
HEF4541B_Q100 v.1	20131021	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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